

Title (en)  
EPOXY RESIN COMPOSITIONS

Title (de)  
EPOXIDHARZZUSAMMENSETZUNGEN

Title (fr)  
COMPOSITIONS DE RÉSINE ÉPOXY

Publication  
**EP 2483353 B1 20131030 (EN)**

Application  
**EP 10761112 A 20100929**

Priority  
• US 24700609 P 20090930  
• US 2010050615 W 20100929

Abstract (en)  
[origin: WO2011041340A1] A low color epoxy resin composition comprising (a) an epoxy resin and (b) at least one an inorganic phosphorous-containing compound stabilizing agent, for example an additive such as sodium pyrophosphate dibasic (SPD) compound; wherein the resulting epoxy resin composition is storage stable and the epoxy resin composition exhibits a low color. The low color epoxy resin composition is used to prepare an epoxy encapsulant which is useful in light emitting diodes (LEDs).

IPC 8 full level  
**C08L 63/00** (2006.01); **C08G 59/62** (2006.01); **C08K 3/32** (2006.01); **H01L 33/56** (2010.01)

CPC (source: EP KR US)  
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C-Set (source: EP US)  
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DOCDB simple family (publication)  
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